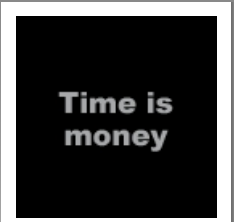


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You may also like...

AMB0582C1RJ

Category:	Advanced Memory Buffers
Generic Part:	AMB0582C1
Market Group:	AMB
Description:	AMB



Parameters

Speed	NA
Temperature	C
Voltage	5.0 V
Status	New
Sample	Yes
Minimum Order Quantity	40
Factory Order Increment	40

Distributor Inventory

No Pricing information is available from our Distributors at this time.

Documents

Type	Title	Size	Revision Date
Flyer	IDT Quick Reference Guide	475 KB	01/28/2008
	Advance Memory Buffer (AMB) Flyer	728 KB	03/27/2008
Product Change Notice	PCN# : TB0801-01 Add SPIL Taiwan as Alternate Test and Backend for IDT AMB Products	87 KB	01/27/2008
White Paper	Green Semiconductor Packaging	960 KB	07/12/2006

Package

Package	FCBGA 655 (RJ655)
Description	FLIP CHIP BGA 24.5 X 19.5 MM 0.80 MM PITCH
Status	Active
Class	PLASTIC
Category	RoHS
Pb (Lead) Free	No
Mark	RJ
Package Type	FCBGA
Lead Count	655
Length	24.5 mm
Width	19.5 mm
Thickness	2.55 mm
Pitch	0.8 mm
Tube / Tray	TRAY
Quantity per Tube/Tray	40
Quantity per Reel	650
Moisture Sensitivity Level (MSL)	4
Moisture Exposure Floor Life	72 hrs@<30C/60%RH
Peak Reflow Temperature	245Å °C
Rebake Conditions	48hrs@125C
Related Package Documents	view documents